N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (mΩ) TYP.	I_D (A)	Q_g (TYP.)
100	1.9 at V_{GS} = 10 V	260	110 nC

FEATURES

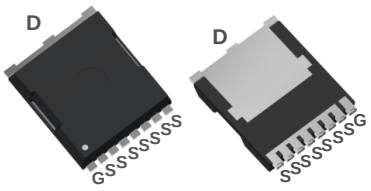
- DT-Trench II Power MOSFET
- 100 % R_g and UIS tested
- High Speed Power Switching

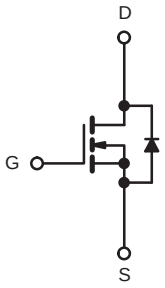
RoHS COMPLIANT

APPLICATIONS

- Power tools
- Synchronous rectification
- Hard Switching and High Speed Circuit
- DC/DCin Telecoms and Inductrial

TOLL Pin Configuration





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	260	A
	T_C = 100 °C		235	
Pulsed Drain Current (t = 100 µs)		I_{DM}	820	
Avalanche Current	L = 0.1 mH	I_{AS}	230	
Single Avalanche Energy [a]		E_{AS}	770	mJ
Maximum Power Dissipation [a]	T_C = 25 °C	P_D	340[b]	W
	T_C = 100 °C		170[b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB Mount) [c]	t ≤ 10 s	R_{thJA}	60	°C/W
Junction-to-Case (Drain)	Steady State	R_{thJC}	0.45	

Notes

a. Duty cycle ≤ 1 %.
b. See SOA curve for voltage derating.
c. When mounted on 1" square PCB (FR4 material).

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA	100	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA	2	-	4	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 100 V, V_{GS} = 0 V	-	-	10	µA
		V_{DS} = 100 V, V_{GS} = 0 V, T_J = 100 °C	-	-	100	
On-State Drain Current [a]	$I_{D(on)}$	V_{DS} ≥ 10 V, V_{GS} = 10 V	260	-	-	A
Drain-Source On-State Resistance [a]	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 25 A	-	1.9	2.5	mΩ
Forward Transconductance [a]	g_{fs}	V_{DS} = 5 V, I_D = 25 A	-	75	-	S
Dynamic [b]						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 50 V, f = 1 MHz	-	7938	-	pF
Output Capacitance	C_{oss}		-	203	-	
Reverse Transfer Capacitance	C_{rss}		-	22	-	
Total Gate Charge [c]	Q_g	V_{DS} = 50 V, V_{GS} = 10 V, I_D = 25 A	-	110	-	nC
Gate-Source Charge [c]	Q_{gs}		-	26	-	
Gate-Drain Charge [c]	Q_{gd}		-	22	-	
Gate Resistance	R_g	f = 1 MHz	-	1.5	-	Ω
Turn-On Delay Time [c]	$t_{d(on)}$	V_{DD} = 50 V, I_D = 25 A, R_g = 6Ω V_{GEN} = 10 V	-	32	-	ns
Rise Time [c]	t_r		-	25	-	
Turn-Off Delay Time [c]	$t_{d(off)}$		-	49	-	
Fall Time [c]	t_f		-	18	-	
Drain-Source Body Diode Ratings and Characteristics [b] (T_C = 25 °C)						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C	-	-	260	A
Pulsed Current (t = 100 µs)	I_{SM}		-	-	800	A
Forward Voltage [a]	V_{SD}	I_F = 25 A, V_{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t_{rr}	I_F = 25 A, di/dt = 100 A/µs	-	78	-	ns
Reverse Recovery Charge	Q_{rr}		-	160	-	nC

Notes

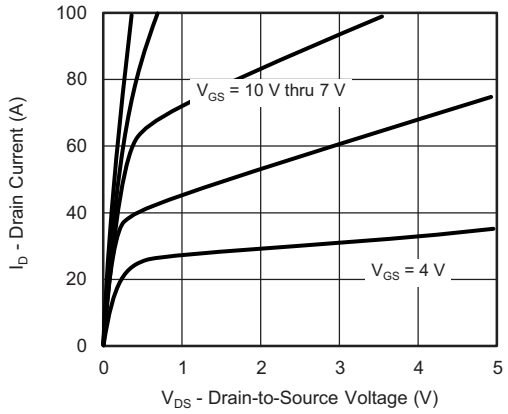
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

b. Guaranteed by design, not subject to production testing.

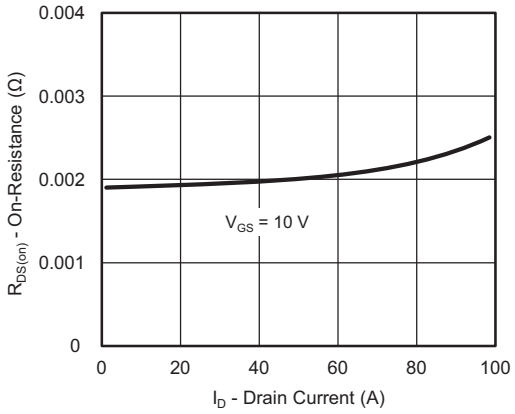
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

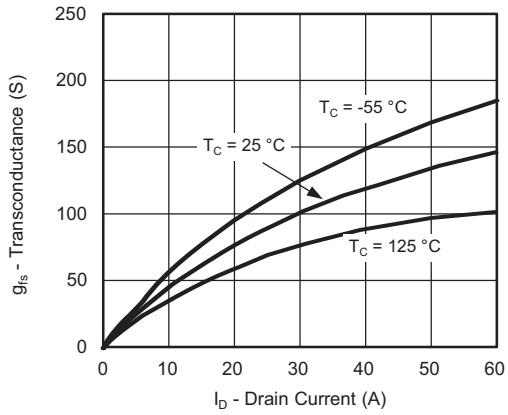
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



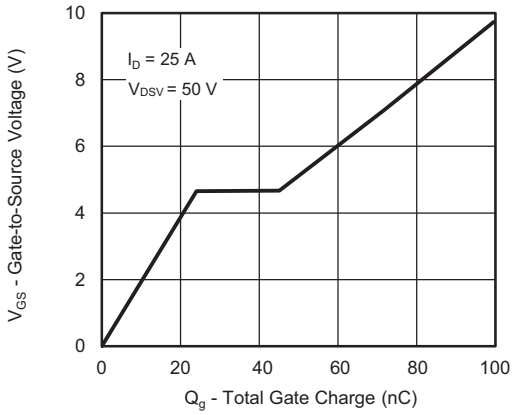
Output Characteristics



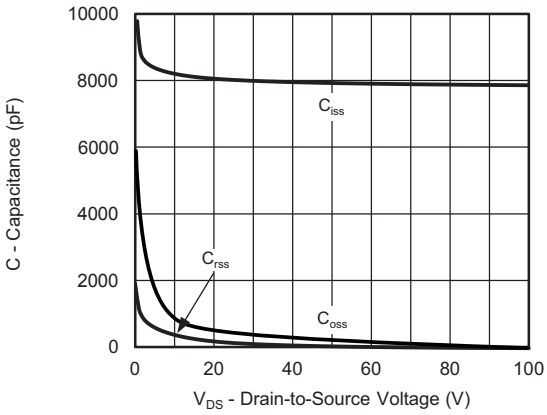
On-Resistance vs. Drain Current



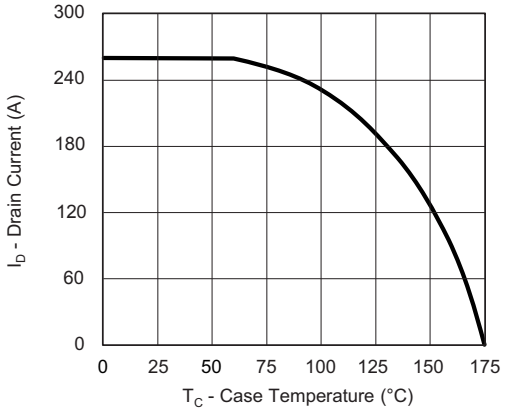
Transconductance



Gate Charge

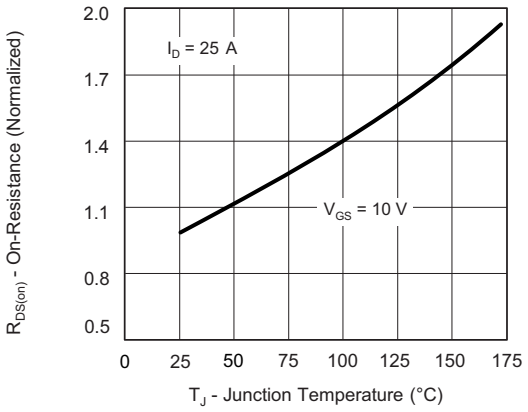


Capacitance

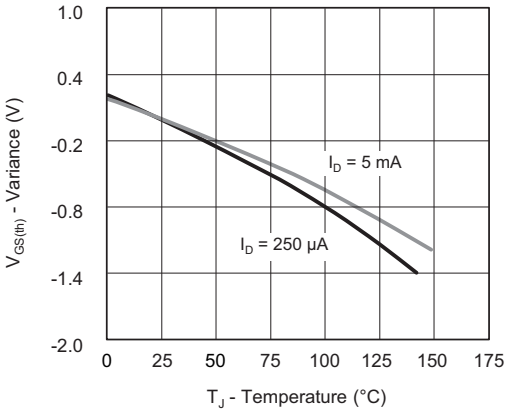


Current De-Rating

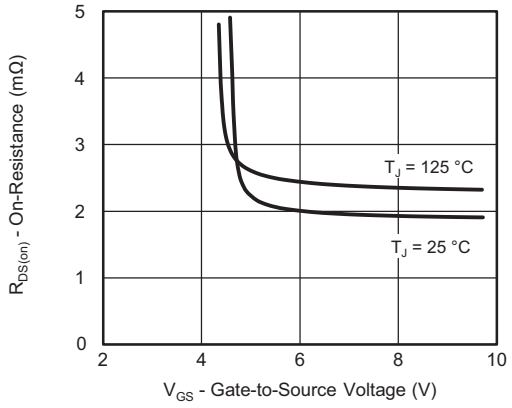
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



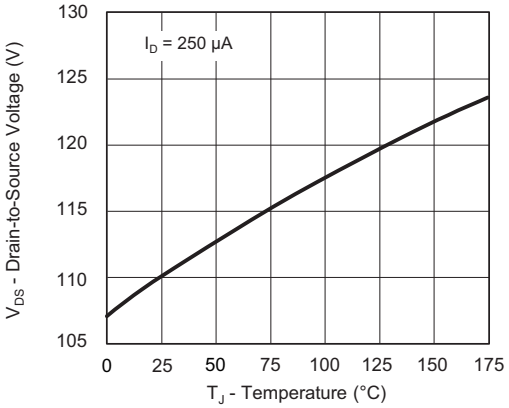
On-Resistance vs. Junction Temperature



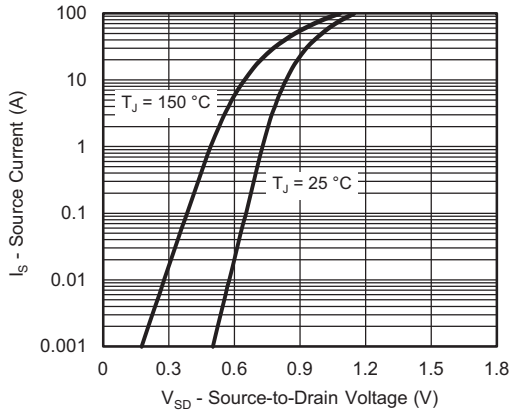
Threshold Voltage



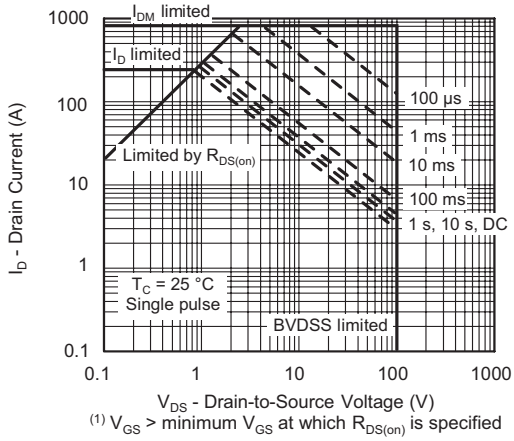
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

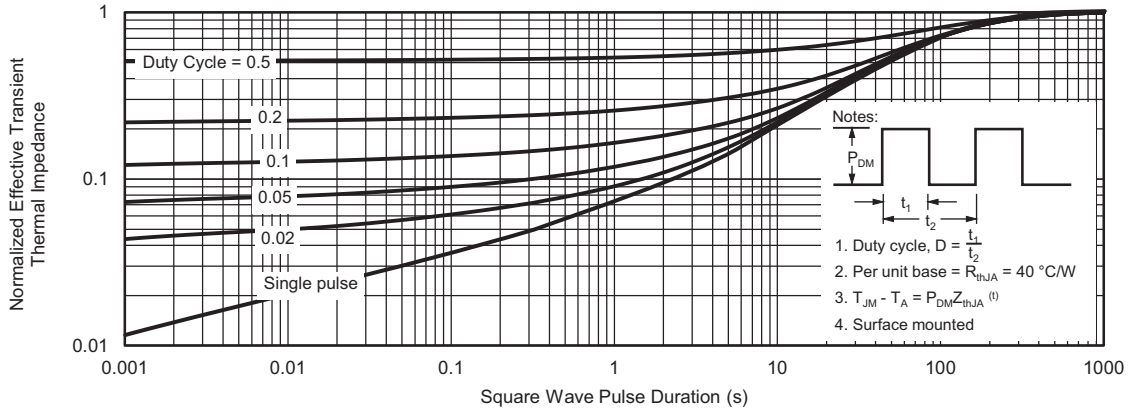


Source Drain Diode Forward Voltage



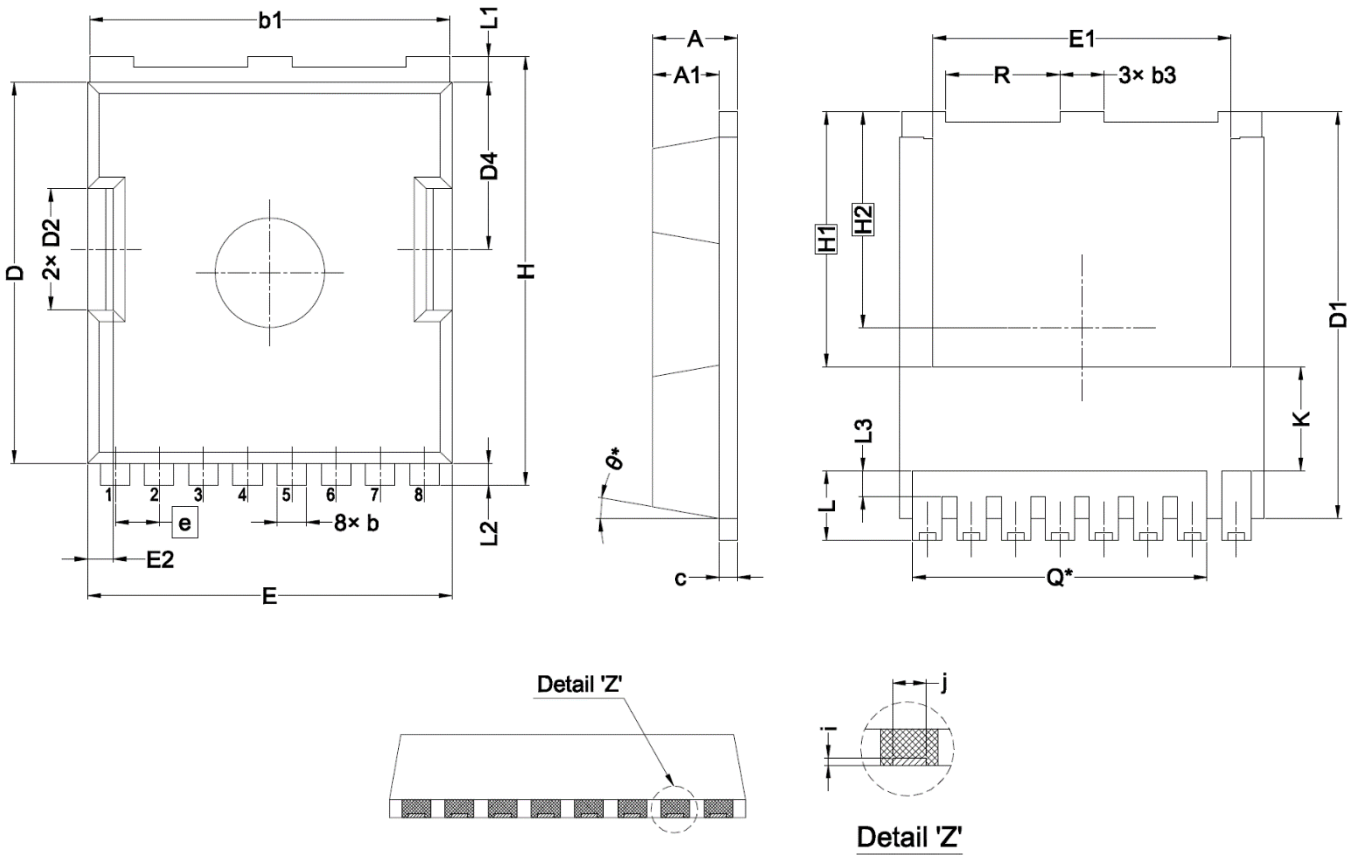
Safe Operating Area

THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



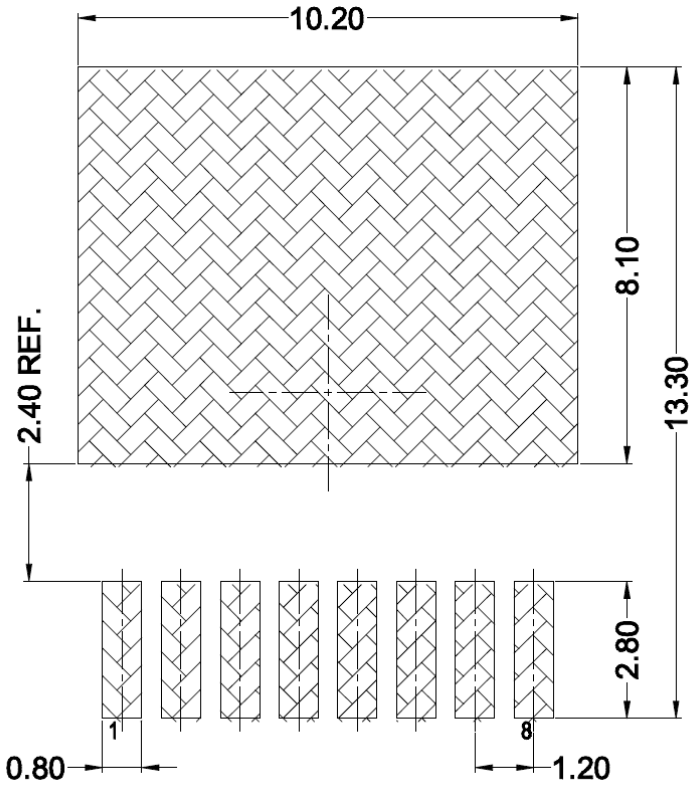
Normalized Thermal Transient Impedance, Junction-to-Ambient

TOLL PACKAGE INFORMATION



SYMBOL	mm			SYMBOL	mm		
	MIN	NOM	MAX		MIN	NOM	MAX
A	2.20	2.30	2.40	H	11.58	11.68	11.78
A1	1.70	1.80	1.90	H1	6.95 BSC		
b	0.70	0.80	0.90	H2	5.89 BSC		
b1	9.70	9.80	9.90	i	0.10 REF		
b3	1.10	1.20	1.30	j	0.46 REF		
c	0.40	0.50	0.60	K	2.80 REF		
D	10.28	10.38	10.48	L	1.40	1.90	2.10
D1	10.98	11.08	11.18	L1	0.60	0.70	0.80
D2	3.20	3.30	3.40	L2	0.50	0.60	0.70
D4	4.45	4.55	4.65	L3	0.30	0.70	0.80
E	9.80	9.90	10.00	N	8		
E1	8.00	8.10	8.20	Q	8.00 REF		
E2	0.60	0.70	0.80	R	3.00	3.10	3.20
e	1.20 BSC			θ	10° REF		

TOLL RECOMMENDED LAND PATTERN



unit : mm

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